

10/522983

DT05 Rec'd PCT/PTO 02 FEB 2005

## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.1

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*Application Information:*

Title of Invention: LASER MACHINING METHOD  
Application Type: regular, utility  
Attorney Docket Number: 740675-59

Botanic Information:

Publication Information:

Suggested Figure for Publication -  
Suggested Classification -  
Suggested Technology Center -  
Total Number of Drawing Sheets -

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22204      \*22204\*

as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

*Domestic Priority Information:*

This is a National Stage of JP application number PCT/JP2003/009896, filed 2003-08-04, now PENDING.

*Foreign Priority Information:*

Doc.No:2002-228311; Country - JP; Date: 2002-08-06 us-priority-claimed

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